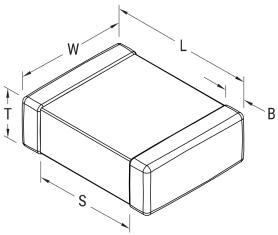


C0805X271KCGACTU

Aliases (C0805X271KCGAC7800)

SMD Comm COG HV Flex, Ceramic, 270 pF, 10%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 0805



Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	1.25mm +/-0.15mm
S	0.75mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	2500	

General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	270 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0 Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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